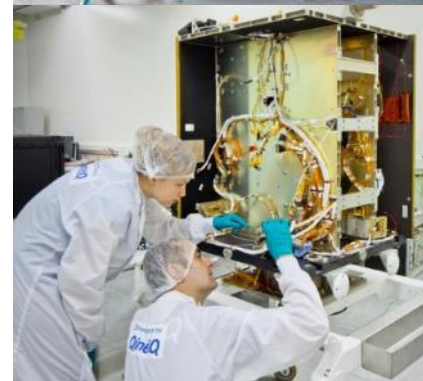
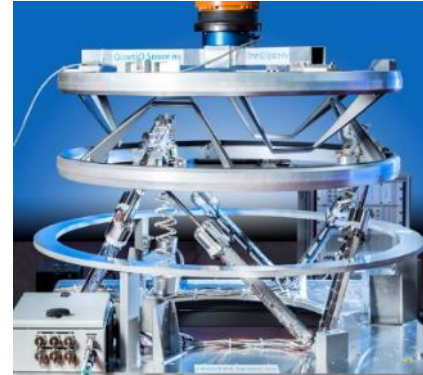
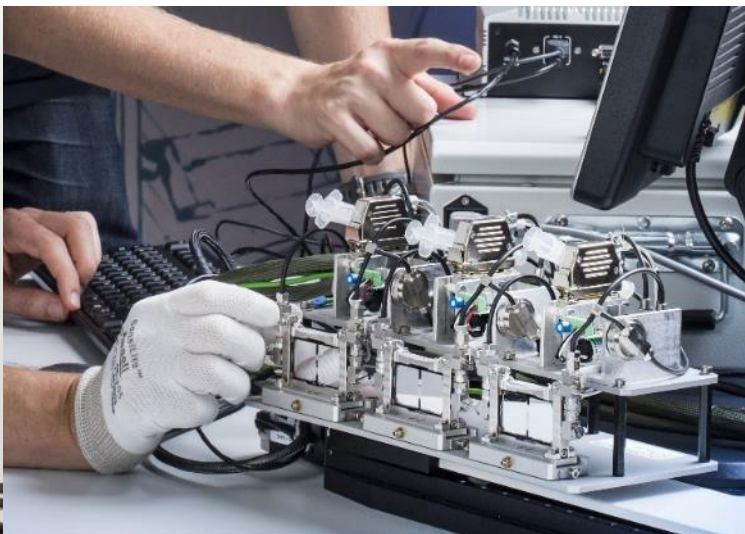


Experience with COTS on ADPMS unit



06 November 2019 – J. De Hert – QinetiQ Space



Agenda

-
- 1 Company Introduction
 - 2 ADPMS Introduction
 - 3 Why COTS?
 - 4 Examples
 - 5 Conclusion
-

Company Introduction

- Founded in 1969 as product developer
- Space activities started in 1983
- Delivered 100+ systems and sub-systems for manned space stations, satellites and interplanetary missions
- Acquired by the QinetiQ group (UK) in 2005
- 170 highly educated specialists employed
- 2 sites in Belgium
- 450m² cleanroom



QinetiQ Space Ground Station

- Located in Belgium, Redu
- ESA satellite ground station
- Jointly operated with SES Astra



QinetiQ Space

- Located in Belgium, Kruibeke
- Offices: 3.742 m², Warehouses: 1.200 m²
- 2 Class 100.000 cleanrooms



Company Introduction



Satellites & Platforms



Scientific Payloads



Subsystems



Downstream services

ADPMS Introduction

- **ADPMS : Advanced Data and Power Management System**
 - Dual lane computer and power system
 - Modular digital boards
 - Intended for platform computer
- **Onboard computer for Proba satellites**
 - Design started in 2000
 - Flight heritage on Proba-2 and Proba-V (16 combined years in orbit)
 - Flight units ready for Proba-3
 - Spin-off used on IXV
- **Parts Usage**
 - General class 3 level parts
 - About 20 different types of commercial COTS parts used on a total almost 300 parts
 - Design predates the ECSS-Q-ST-60-13C



Why COTS?

- **Because of functional reasons (No suitable FM equivalent available)**
 - However market and availability evolves
 - Several components could now be replaced by MIL / ECSS / Hi-rel parts
 - But, unless replacement is size/function compatible, risk of change is considered too high
 - Very dense PCBs prevent updating without complete redesign
 - Loss of flight heritage / qualification
 - excellent performance of most COTS parts in space
- **NOT because of cost reasons**
 - Component parts cost is lower however
 - Upscreening costs
 - Parts approval flow (repeated for each project)
 - Radiation testing when applicable
 - Solder qualification
 - (relifing)
 - Difficult to assess total cost at start of project
 - Accumulated cost of PAD discussions and extra tests over consecutive projects
 - Obsolescence, manufacturer changes or batch variability (no long term assurance)

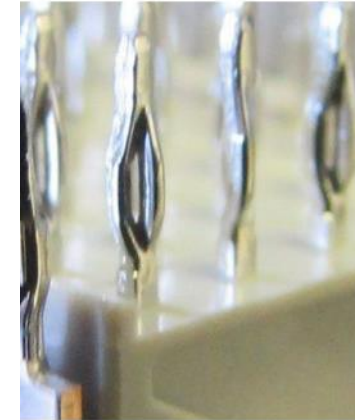
Why COTS?

- Design concept
 - cPCI compliant modular boards and backplane with rear-IO
 - Multiple types of cPCI connectors
- PCB space constraints
 - Decoupling of CCGA /MCGA devices
 - 0402 ceramic capacitors
 - Large value / small size ceramics
 - Qualified parts too large to accommodate
 - SOT23 plastic package dual schottky diode
- Functionality and performance
 - Memories required for LEON processor
 - Commercial SRAM and FLASH
 - Low power analog housekeeping
 - ADC, OPAMP and instrumentation amplifier



Design concept : cPCI connectors

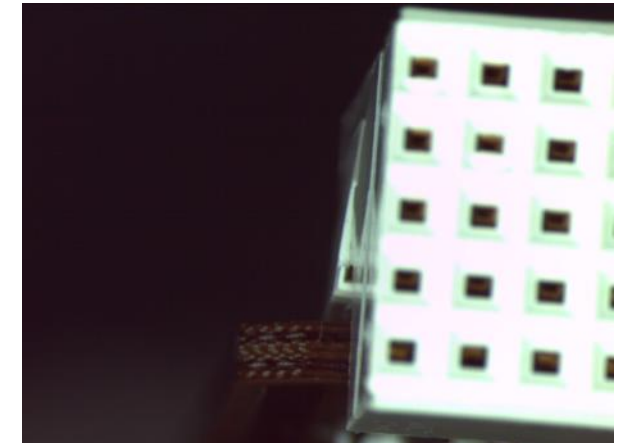
- Part selection and Qualification
 - Initially parts from Tyco were selected with Sn/Pb leads
 - For each FM lot a press-fit qualification campaign was required
 - Extensive Lot acceptance testing, structural analysis performed
- Lessons learned
 - Standard PCB manufacturing with hot-oil reflow finish not ideal for press-fit mounting due to tolerance restrictions.
 - Due to obsolescence change required to other manufacturer (Harting)
 - Different tolerances and small dimension differences caused damaged connectors and pins
 - Same type of connector but internal construction is significantly different between manufacturers.
- Current status
 - cPCI equivalent connectors for space are available but limited choice and no reliable intermateability with other brands can be warranted.



Tyco

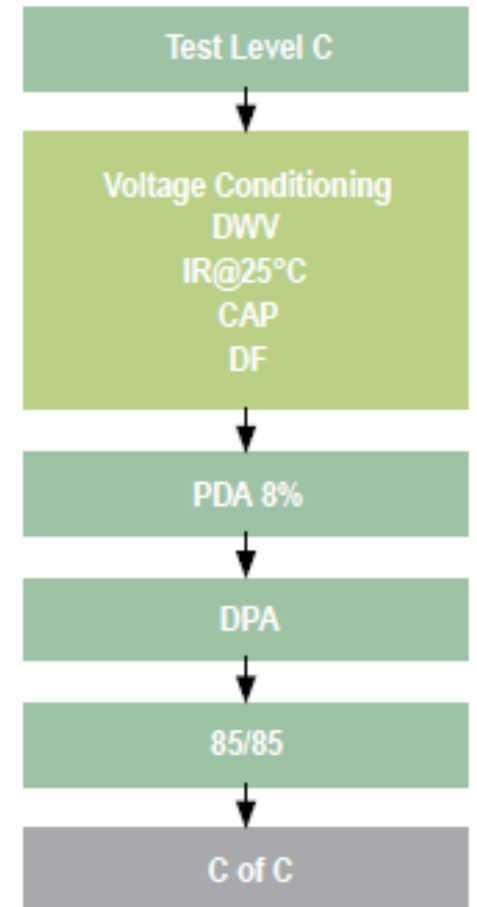


Harting



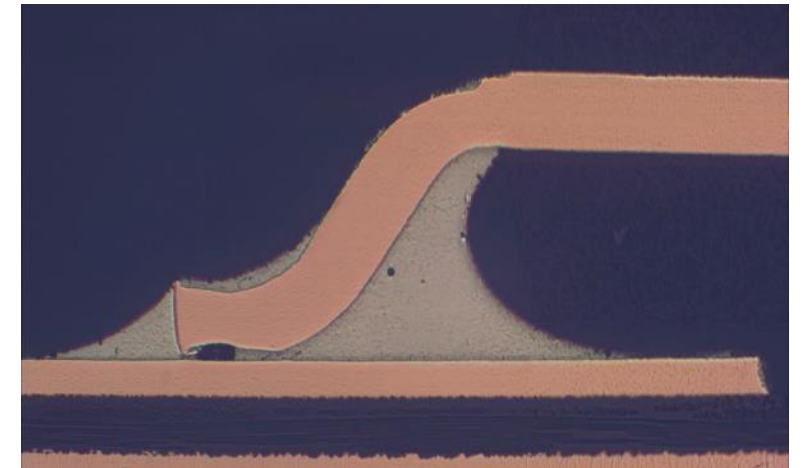
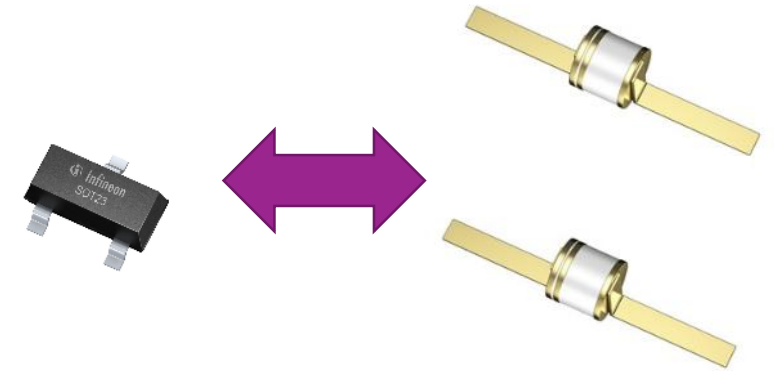
PCB space constraints : Ceramic capacitors

- Part selection and upscreening
 - Commercial “Hi-rel” 0402, 0805 and 1206 caps from Kemet
 - Procured with traceability from authorized distributor
 - Manufacturer test level “C”
 - SnPb finish
- Lessons learned
 - Solder qualification and operational performance successful
 - Lifetime issues, solderability decreases
 - Solderability failed in reusing previous flight lot, new procurement required
 - Sourcing new SnPb COTS parts difficult with increased lead time (non standard product)
- Current status
 - 0402 size capacitors are now available from European space-qualified manufacturers
 - High lead time and considerable higher cost than MIL CDR types
 - Used in new designs requiring class 3 or better.



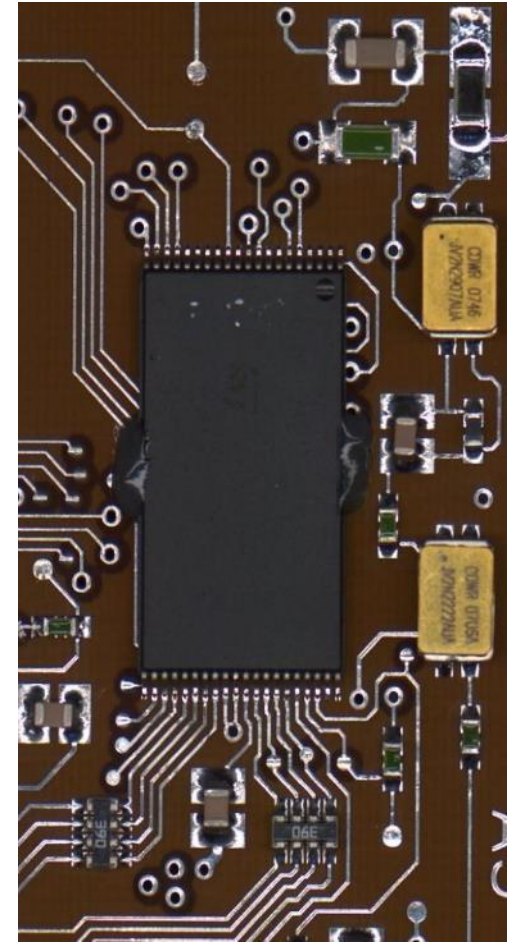
PCB space constraints : SOT23 plastic package dual schottky diode

- Part selection
 - Multiple small signal schottky diodes required on small space
 - Space qualified single diodes available but FM package too large
 - Initial part from ON-semi selected
- Lessons learned
 - Obsolete ON-Semi Flight batch failed 7-year relifing
 - Same BAS40-04 component from Infineon selected as replacement
 - Solder qualification required for all new batches of plastic parts
 - No issues for the older On-Semi part
 - Initial solder qualification of Infineon part failed due to difference in lead
 - Obsolescence and differences between commercial parts resulted in an unexpected cost and delay.
- Current status
 - Still a need for small diode packages
 - New designs with no COTS use more PCB area for same configuration



Functionality and performance : Memories

- Part selection and upscreening
 - Components were selected because some radiation data was already available
 - COTS memories have a short market lifetime. Large number was purchased. FM assembly uses only a few but quantities for upscreening and testing are significant.
 - Solder qualification required on each lot of plastic parts
 - Radiation test cost is extensive
 - Total dose testing
 - Single event latchup testing
 - Single event effects testing (SEU, SEFI)
 - In some cases proton SEE testing was required (sensitive part)
- Lessons learned
 - Combining all test costs the memories become the most expensive parts
 - Quick obsolescence and short lifespan of non hermetic plastic parts is a project risk and eventually limits the time a design can be reused.
 - Beware of variations in a “single lot” COTS parts
- Current status
 - For new projects external qualified devices (e.g. 3D-plus) are preferred



Functionality and performance : Analog Frontend

- Part selection and upscreening
 - Core is a radhard RTAX FPGA
 - Power conditioning with radhard parts
 - Critical parts for analog acquisition however are all COTS
 - Low speed ADC with SPI interface
 - Opamp
 - Instrumentation amplifier
 - Several high precision resistor divider arrays
- Lessons learned
 - To date no degradation is notable on the DAM housekeeping telemetry on both the Proba-2 and Proba-V satellites
 - No SEFI detected over the years for the ADC
- Current status
 - Qualified devices available on the market



Conclusion

- COTS can be successfully used in space
- Risk of obsolescence
- Significant differences between batches and manufacturers
- Upscreening costs per part are very high for small series

COTS comes with a COST

QINETIQ